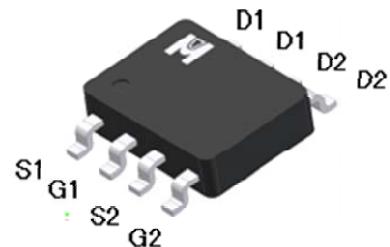
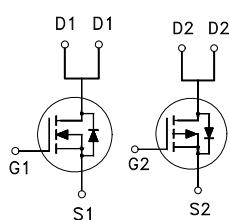


N & P-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

	N-CH	P-CH
BV _{DSS}	20V	-20V
R _{DSON} (MAX.)	30.5mΩ	100mΩ
I _D	6.5A	-4.2A



Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS		UNIT
Gate-Source Voltage		V _{GS}	N-CH	P-CH	V
			±12	±12	
Continuous Drain Current	T _A = 25 °C	I _D	6.5	-4.2	A
	T _A = 100 °C		4.5	-3.3	
Pulsed Drain Current ¹		I _{DM}	26	-16.8	
Power Dissipation	T _A = 25 °C	P _D	2		W
	T _A = 100 °C		0.8		
Operating Junction & Storage Temperature Range		T _j , T _{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	R _{θJC}	25	62.5	°C / W
Junction-to-Ambient ³	R _{θJA}			

¹Pulse width limited by maximum junction temperature.

²Duty cycle ≤ 1%

³62.5°C / W when mounted on a 1 in² pad of 2 oz copper.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	N-CH	20		V
		$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	P-CH	-20		
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	N-CH	0.45	0.75	1.2
		$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	P-CH	-0.45	-0.75	-1.2
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 12\text{V}$	N-CH			± 100
		$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 12\text{V}$	P-CH			± 100
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 16\text{V}, V_{\text{GS}} = 0\text{V}$	N-CH			1
		$V_{\text{DS}} = -16\text{V}, V_{\text{GS}} = 0\text{V}$	P-CH			-1
		$V_{\text{DS}} = 16\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$	N-CH			10
		$V_{\text{DS}} = -16\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$	P-CH			-10
On-State Drain Current ¹	$I_{\text{D}(\text{ON})}$	$V_{\text{DS}} = 5\text{V}, V_{\text{GS}} = 4.5\text{V}$	N-CH	6.5		A
		$V_{\text{DS}} = -5\text{V}, V_{\text{GS}} = -4.5\text{V}$	P-CH	-4.2		
Drain-Source On-State Resistance ¹	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 4.5\text{V}, I_D = 6.5\text{A}$	N-CH		26	30.5
		$V_{\text{GS}} = -4.5\text{V}, I_D = -3.5\text{A}$	P-CH		85	100
		$V_{\text{GS}} = 2.5\text{V}, I_D = 3\text{A}$	N-CH		40	50
		$V_{\text{GS}} = -2.5\text{V}, I_D = -2\text{A}$	P-CH		120	150
Forward Transconductance ¹	g_{fs}	$V_{\text{DS}} = 5\text{V}, I_D = 6.5\text{A}$	N-CH		7	S
		$V_{\text{DS}} = -5\text{V}, I_D = -3.5\text{A}$	P-CH		4.5	
DYNAMIC						
Input Capacitance	C_{iss}	$N\text{-CH}$ $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 15\text{V}, f = 1\text{MHz}$ $P\text{-CH}$ $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = -15\text{V}, f = 1\text{MHz}$	N-CH		280	pF
			P-CH		382	
Output Capacitance	C_{oss}		N-CH		47	pF
			P-CH		70	
Reverse Transfer Capacitance	C_{rss}		N-CH		38	pF
			P-CH		60	
Gate Resistance	R_g	$V_{\text{GS}} = 15\text{mV}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$	N-CH		2.0	Ω
			P-CH		5.0	

Total Gate Charge ^{1,2}	Q_g	N-CH $V_{DS} = 10V, V_{GS} = 4.5V,$ $I_D = 6.5A$ P-CH $V_{DS} = -10V, V_{GS} = -4.5V,$ $I_D = -3.5A$	N-CH		6.2		nC
Gate-Source Charge ^{1,2}	Q_{gs}		P-CH		7.2		
Gate-Drain Charge ^{1,2}	Q_{gd}		N-CH		0.9		
Turn-On Delay Time ^{1,2}	$t_{d(on)}$		P-CH		1.2		
Rise Time ^{1,2}	t_r		N-CH		2.1		
Turn-Off Delay Time ^{1,2}	$t_{d(off)}$		P-CH		2.3		
Fall Time ^{1,2}	t_f	N-CH $V_{DS} = 10V,$ $I_D = 1A, V_{GS} = 4.5V, R_{GS} = 6\Omega$ P-CH $V_{DS} = -10V,$ $I_D = -1A, V_{GS} = -4.5V, R_{GS} = 6\Omega$	N-CH		5		nS
			P-CH		5		
			N-CH		10		
			P-CH		12		
			N-CH		20		
			P-CH		23		
		N-CH $I_D = -1A, V_{GS} = -4.5V, R_{GS} = 6\Omega$	N-CH		8		V
			P-CH		10		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_c = 25^\circ C$)

Continuous Current	I_S	$I_F = I_S, V_{GS} = 0V$	N-CH		2	A	
Pulsed Current ³	I_{SM}		P-CH		-2		
Forward Voltage ¹	V_{SD}		N-CH		8	V	
			P-CH		-8		
			N-CH		1.3	V	
			P-CH		-1.3		

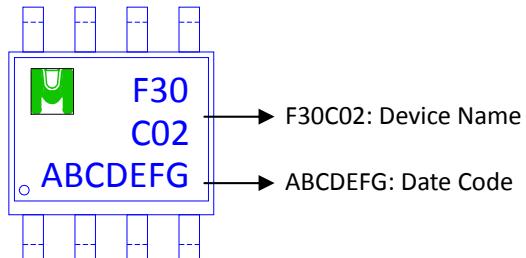
¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

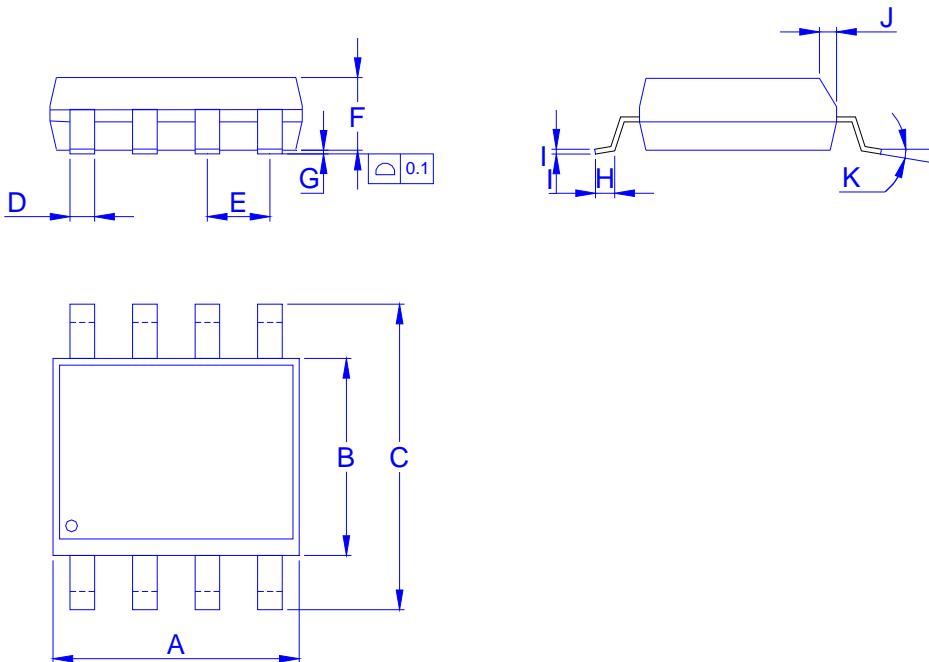
³Pulse width limited by maximum junction temperature.

Ordering & Marking Information:

Device Name: EMF30C02G for SOP-8



Outline Drawing

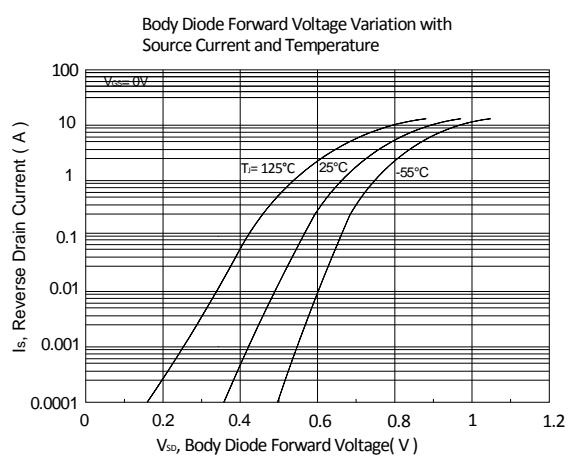
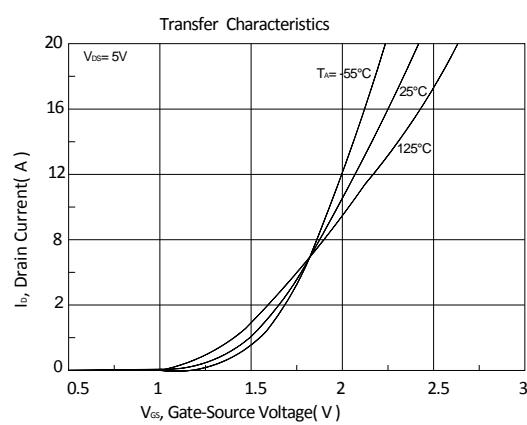
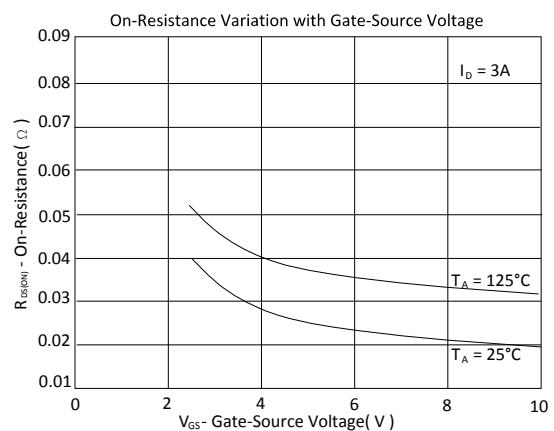
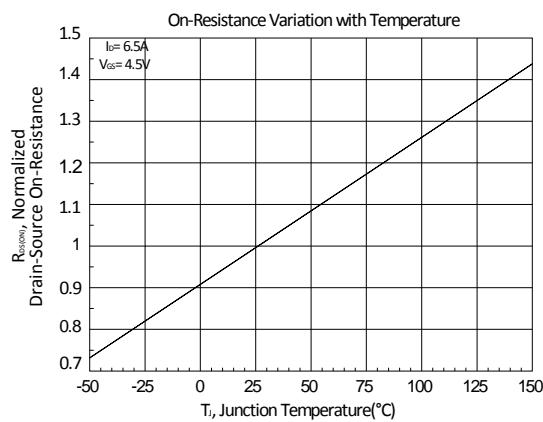
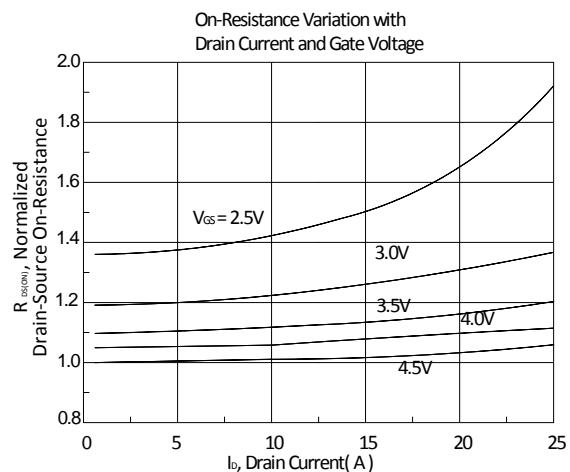
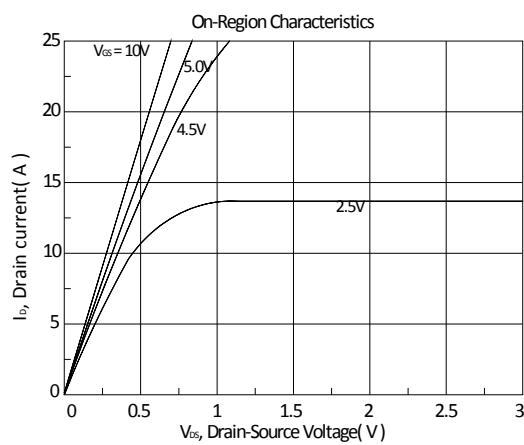


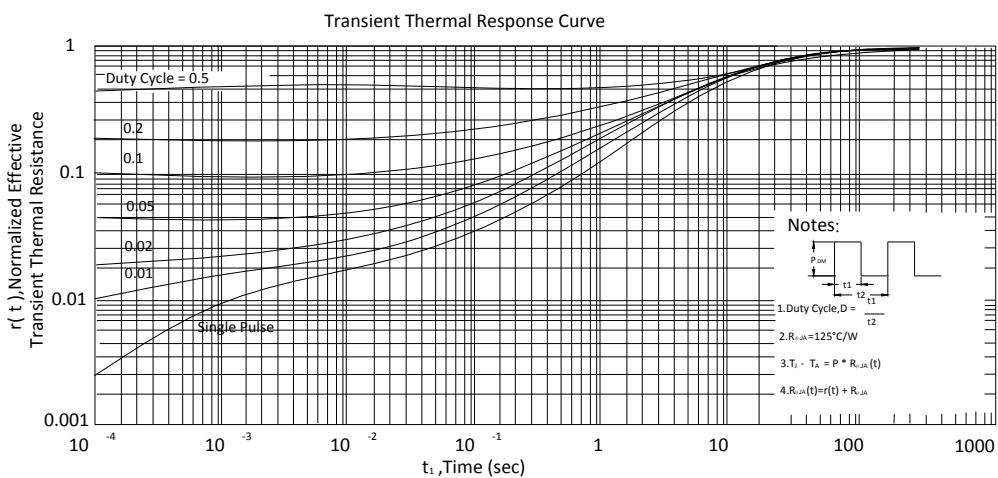
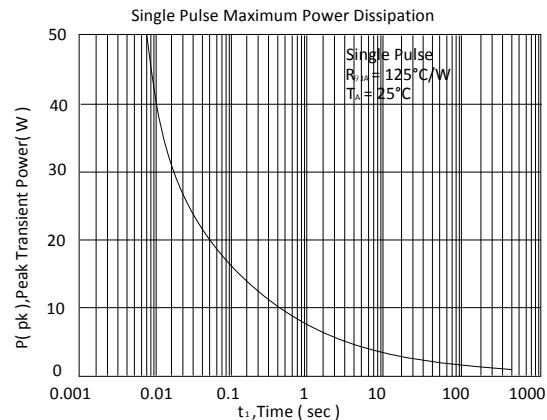
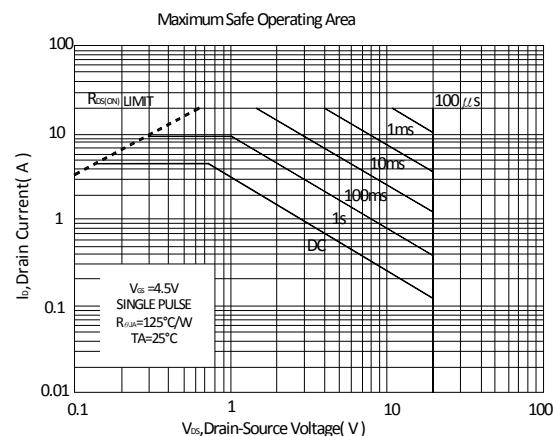
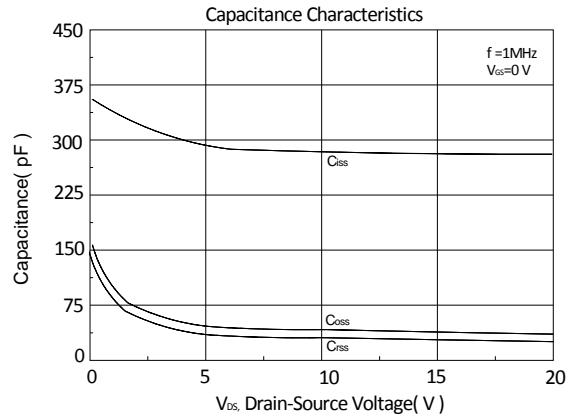
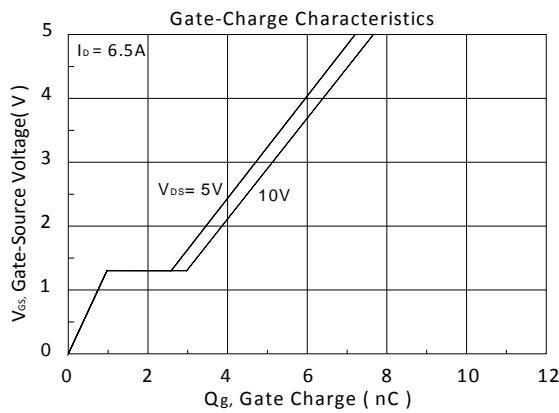
Dimension in mm

Dimension	A	B	C	D	E	F	G	H	I	J	K
Min.	4.70	3.70	5.80	0.33		1.20	0.08	0.40	0.19	0.25	0°
Typ.					1.27						
Max.	5.10	4.10	6.20	0.51		1.62	0.28	0.83	0.26	0.50	8°



N-Channel





P-Channel

